



2017 1st Electron Devices Technology and Manufacturing Conference (EDTM)

<http://ewh.ieee.org/conf/edtm/2017>

**At Toyama International Conference Center, Toyama, Japan
February 28th to March 2nd, 2017**

The Electron Devices Technology and Manufacturing (EDTM) Conference, 2017 provides sponsorship program. The EDTM aims to create a forum among device, process/tool, and material community for innovation. We are confident that the key note talks, the tutorials and short courses, as well as the quality of papers that will be presented will make a successful and top scientific and industry event. As a sponsor, your company will benefit from all the visibility opportunities offered by this success and gain access to researchers and directors from world's leading R&D institutes and organizations.

Sponsorship Packages	Cost (JPY)
Platinum Sponsor Packages	JPY 1,000,000
Gold Sponsor Packages	JPY 500,000
Silver Sponsor Packages	JPY 300,000
Bronze Sponsor Packages	JPY 200,000

All sponsorship packages can be customized to suit your company's preference. If you are only interested in an exhibition booth, exhibition package is available. Following is the benefit table for each sponsor grade.

Benefits	Platinum	Gold	Silver	Bronze
Company/organization name and sponsor level on all conference material (flyers, proceedings, website, emails, display panel /	Yes	No	No	No
Complimentary exhibition booth	1	1	No	No
Full conference registrations and access to social events (#)	4	2	1	0
Company/organization name, logo and sponsor level on the "Thank You to Our Sponsors" slide shown at the Opening session	Yes	Yes	Yes	Yes
Company/Organization logo and sponsor level in the conference proceedings	Yes	Yes	Yes	Yes
Company/Organization logo, sponsor level and website URL on the website of the conference	Yes	Yes	Yes	Yes

For more information please contact:

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For application please contact

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